# •addon

## XFP-10GB-DW50-100-AO

MSA and TAA 10GBase-DWDM 100GHz XFP Transceiver (SMF, 1537.40nm, 100km, LC, DOM)

## Features

- INF-8077i Compliance
- Temperature-stabilized EML transmitter and PIN receiver
- Duplex LC Connector
- Commercial Temperature 0 to 70 Celsius
- Single-mode Fiber
- Hot Pluggable
- Excellent ESD Protection
- Metal with Lower EMI
- RoHS Compliant and Lead Free



## **Applications**

- 8x/10x Fibre Channel
- 10x Gigabit Ethernet over DWDM
- Access, Metro and Enterprise

## **Product Description**

This MSA Compliant XFP transceiver provides 10GBase-DWDM throughput up to 100km over single-mode fiber (SMF) using a wavelength of 1537.40nm via an LC connector. It is built to MSA standards and is uniquely serialized and data-traffic and application tested to ensure that they will integrate into your network seamlessly. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

AddOn's transceivers are RoHS compliant and lead-free.

TAA refers to the Trade Agreements Act (19 U.S.C. & 2501-2581), which is intended to foster fair and open international trade. TAA requires that the U.S. Government may acquire only "U.S. – made or designated country end products."



Rev. 062822

## **Regulatory Compliance**

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

## Wavelength Guide (100GHz ITU-T Channel)

Channel #	Frequency (THz)	Center Wavelength (nm)
34	193.4	1550.12
35	193.5	1549.32
36	193.6	1548.51
37	193.7	1547.72
38	193.8	1546.92
39	193.9	1546.12
40	194.0	1545.32
41	194.1	1544.53
42	194.2	1543.73
43	194.3	1542.94
44	194.4	1542.14
45	194.5	1541.35
46	194.6	1540.56
47	194.7	1539.77
48	194.8	1538.98
49	194.9	1538.19
50	195.0	1537.40
51	195.1	1536.61
52	195.2	1535.82
53	195.3	1535.04
54	195.4	1534.25
55	195.5	1533.47
56	195.6	1532.68
57	195.7	1531.90
58	195.8	1531.12
59	195.9	1530.33
60	196.0	1529.55
61	196.1	1528.77

# **Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit
Maximum Supply Voltage	Vcc3	-0.5	3.6	V
	Vcc5	-0.5	6	V
Storage Temperature	TS	-40	85	°C
Operating Temperature	ТО	0	70	°C
Operating Humidity	RH	5	95	%
Receiver power	R <sub>MAX</sub>		-7	dBm
Maximum bitrate	B <sub>max</sub>	9.95	11.3	Gbps

## **Electrical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Power Supply Voltage	Vcc3	3.135	3.30	3.465	V	
	Vcc5	4.75	5.0	5.25	V	
Power Supply Current	lcc3			750	mA	
Power Supply Current	Icc5			500	mA	
Power Dissipation	PD			3500	mW	
Transmitter						
Differential data input swing	Vin,pp	120		1000	mVp-p	
Input differential impedance	Zin		100		Ω	
Tx_Disable, P_Down/RST	V <sub>IH</sub>	2.0		V <sub>CC3</sub> +0.3	V	
	VIL	-0.3		0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout, pp	340		850	mVp-p	1
Output differential impedance	Zin		100		Ω	
Data Output Rise Time, Fall Time	t <sub>r</sub> , t <sub>f</sub>	24			ps	2
Rx_LOS, Mod_NR, Interrupt	V <sub>он</sub>	V <sub>CCHOST</sub> -0.5		V <sub>CCHOST</sub> +0.3	V	3
	V <sub>OL</sub>	0		0.4	V	3

Notes:

- 1. Internally AC coupled but requires an external  $100\Omega$  differential termination.
- 2. 20-80%.
- 3. Loss of Signal is an open collector output. Should be pulled up with a  $4.7k\Omega$ -10k $\Omega$  resistor on the host board.

# **Optical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Transmitter						
Launch Average Optical Power	Ро	1		+4	dBm	1
Center Wavelength Range	λς	1528.77		1563.86	nm	
Center Wavelength Spacing			100		GHz	
Center Wavelength Tolerance	Δλς	-100		100	pm	
Extinction Ratio	EX	9			dB	2
Spectral Width (-20dB)	Δλ			0.3	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average Optical Power (Laser Off)	POFF			-30	dBm	1
Eye Diagram	ITU-T G.691 SDH STM-64 L-64.2 compatible					2
Receiver						
Center Wavelength	λς	1528		1565	nm	
Receiver Sensitivity @ 9.953Gb/s	S			-26.0	dBm	3
Receiver Overload (P <sub>avg</sub> )	P <sub>OL</sub>	-7.0			dBm	3
Optical Return Loss	ORL	27			dB	
LOS De-Assert	LOS <sub>D</sub>			-27	dBm	
LOS Assert	LOS <sub>A</sub>	-38			dBm	
LOS Hysteresis		0.5			dB	

## Notes:

- 1. The optical power is launched into  $9/125\mu m$  SMF.
- 2. Measured with a PRBS 2<sup>31</sup>-1 test pattern @ 9.953Gbps.
- 3. Measured with worst ER; 1550nm; PRBS 2<sup>31</sup>-1 test pattern @ 9.953Gb/s, BER<10<sup>-12</sup>.

# **Pin Descriptions**

Pin	Symbol	Name/Descriptions	Ref.
1	GND	Module Ground	
2	Vee5	(not required)	
3	MOD_DESEL	Module De-select; When Held low allows the module to respond to 2-wire serial interface. LVTTL-I	
4	/INTERRUPT	Interrupt; Indicates presence of an important condition which can be read via the 2-wire serial interface. LVTTL-O	2
5	TX_DIS	Transmitter Disable. Logic1 indicates laser output disabled, LVTTL-I	
6	VCC5	+5V Power Supply (Not required)	
7	GND	Module Ground	1
8	VCC3	+3.3V Power Supply	
9	VCC3	+3.3V Power Supply	
10	SCL	2-Wire Serial Interface Clock. LVTTL-I	2
11	SDA	2-Wire Serial Interface Data Line. LVTTL-I/O	2
12	MOD_Abs	Indicates Module is not present. Grounded in the Module. LVTTL-O	2
13	MOD_NR	Module Not Ready; Indicating Module Operational Fault. Open-collector. LVTTL-O	2
14	RX_LOS	Loss of Signal indication. Logic 1 indicates loss of Signal. Open-collector. LVTTL-O	2
15	GND	Module Ground	1
16	GND	Module Ground	1
17	RD-	Receiver Inverted Data Output. CML-O	
18	RD+	Receiver Non-Inverted Data Output. CML-O	
19	GND	Module Ground	1
20	VCC2	+1.8V Power Supply (Not required).	3
21	P_DOWN/RST	Power down; When high, requires the module to limit power consumption to 1.5W or below. 2-Wire serial interface must be functional in the low power mode. LVTTL-I Reset; The falling edge initiates a complete reset of the module including the 2-	-
22	VCC2	wire serial interface, equivalent to a power cycle. LVTTL-I +1.8V Power Supply (Not required)	3
23	GND	Module Ground	1
24	REFCLK+	Reference Clock (Not required)	
25	REFCLK-	Reference Clock (Not required)	
26	GND	Module Ground	1
27	GND	Module Ground	1
28	TD-	Transmitter Inverted Data Input. CML-I	
29	TD+	Transmitter Non-Inverted Data Input. CML-I	
30	GND	Module Ground	1

## Notes:

- 1. Module ground pins GND are isolated from the module case and chassis ground within the module.
- 2. Open collector; should be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.6V on the host board.
- 3. The pins are open within module.





## **Recommended Circuit Schematic**



## **Mechanical Specifications**

Small Form Factor Pluggable (XFP) transceivers are compatible with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).



## **EEPROM Information**

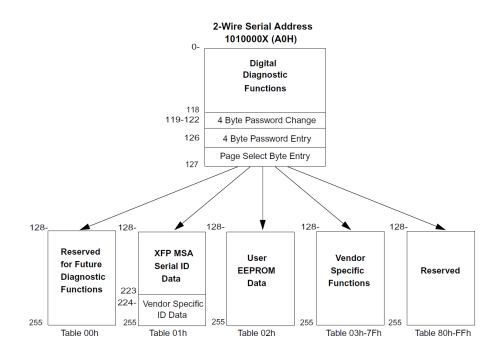
## **Management Interface**

XFP 2-wire serial interface is specified in the Chapter 4 of the XFP MSA specification. The XFP 2-wire serial interface is used for serial ID, digital diagnostics, and certain control functions. The 2-wire serial interface is mandatory for all XFP modules. The 2-wire serial interface address of the XFP module is 1010000X(A0h). In order to access to multiple modules on the same 2-wire serial bus, the XFP has a MOD\_DESEL(module deselect pin). This pin (which is pull high or deselected in the module) must be held low by the host to select of interest and allow communication over 2-wire serial interface. The module must not respond to or accept 2-wire serial bus instructions unless it is selected.

## **XFP Management Interface**

XFP Management interface is specified in the Chapter 5 of the XFP MSA specification. The Figure 1 shows the structure of the memory map. The normal 256 Byte address space is divided into lower and upper blocks of 128 Bytes. The lower block of 128 Byte is always directly available and is used for the diagnostics and control functions that must be accessed repeatedly. Multiple blocks of memories are available in the upper 128 Bytes of the address space. These are individually addressed through a table select Byte which the user enters into a location in the lower address space. The upper address space tables are used for less frequently accessed functions and control space for future standards definition.

EEPROM memory map specific data field description is as below:



## **About AddOn Networks**

In 1999, AddOn Networks entered the market with a single product. Our founders fulfilled a severe shortage for compatible, cost-effective optical transceivers that compete at the same performance levels as leading OEM manufacturers. Adhering to the idea of redefining service and product quality not previously had in the fiber optic networking industry, AddOn invested resources in solution design, production, fulfillment, and global support.

Combining one of the most extensive and stringent testing processes in the industry, an exceptional free tech support center, and a consistent roll-out of innovative technologies, AddOn has continually set industry standards of quality and reliability throughout its history.

Reliability is the cornerstone of any optical fiber network and is in engrained in AddOn's DNA. It has played a key role in nurturing the long-term relationships developed over the years with customers. AddOn remains committed to exceeding industry standards with certifications from ranging from NEBS Level 3 to ISO 9001:2005 with every new development while maintaining the signature reliability of its products.

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